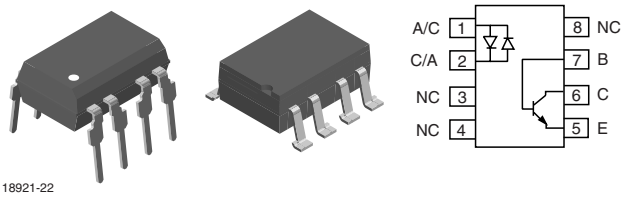
Optocoupler, Phototransistor Output, AC Input, with Base Connection



FEATURES

- AC or polarity insensitive inputs
- Continuous forward current, 130 mA
- Built-in reverse polarity input protection
- Improved CTR symmetry
- Industry standard DIP package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

Pb-free

e3

RoHS COMPLIANT

DESCRIPTION

The IL255 is a bidirectional input optically coupled isolator consisting of two high current GaAs infrared LEDs coupled to a silicon NPN phototransistor. The IL255 has a minimum CTR of 20 %.
This optocoupler is ideal for applications requiring AC signal detection and monitoring.

APPLICATIONS

- Telecommunications
- Ring detection
- Loop current detector

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- DIN EN 60747-5-5 (VDE 0884) available with option 1
- BSI IEC 60950; IEC 60065

ORDER INFORMATION

PART	REMARKS
IL255	CTR > 20 %, DIP-6
IL255-1	CTR 20 % to 80 %, DIP-6
IL255-2	CTR > 50 %, DIP-6
IL255-X007	CTR > 20 %, SMD-6 (option 7)
IL255-X009	CTR > 20 %, SMD-6 (option 9)

Note
For additional information on the available options refer to option information.

ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
INPUT				
Peak pulsed current	1 µs, 300 pps	I_{FP}	3	A
Forward continuous current		I_F	130	mA
Power dissipation		P_{diss}	175	mW
Derate linearly from 25 °C			2.3	mW/°C
OUTPUT				
Collector emitter breakdown voltage		BV_{CEO}	30	V
Emitter base breakdown voltage		BV_{EBO}	5	V
Collector base breakdown voltage		BV_{CBO}	70	V
Power dissipation		P_{diss}	200	mW
Derate linearly from 25 °C			2.6	mW/°C

ABSOLUTE MAXIMUM RATINGS

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
COUPLER				
Isolation test voltage between emitter and detector		V_{ISO}	5300	V_{RMS}
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Isolation resistance	V_{IO} = 500 V, T_{amb} = 25 °C	R_{IO}	≥ 10^{12}	Ω
	V_{IO} = 500 V, T_{amb} = 100 °C	R_{IO}	≥ 10^{11}	Ω
Total dissipation		P_{tot}	250	mW
Derate linearly from 25 °C			3.3	mW/°C
Storage temperature		T_{stg}	- 55 to + 150	°C
Operating temperature		T_{amb}	- 55 to + 100	°C
Lead soldering time at ≥ 260 °C			10	s

Note

T_{amb} = 25 °C, unless otherwise specified.
Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	I_F = ± 100 mA		V_F		1.4	1.7	V
OUTPUT							
Collector emitter breakdown voltage	I_C = 10 mA		BV_{CEO}	30	50		V
Emitter collector breakdown voltage	I_E = 10 µA		BV_{ECO}	7	10		V
Collector base breakdown voltage	I_C = 100 µA		BV_{CBO}	70			V
Emitter base breakdown voltage	I_E = 100 µA		BV_{EBO}	70			V
Collector emitter leakage current	V_{CE} = 10 V		I_{CEO}		5	50	nA
COUPLER							
Collector emitter saturation voltage	I_F = ± 10 mA, I_C = 0.5 mA	IL255	V_{CEsat}			0.4	V
	I_F = ± 100 mA, I_C = 1 mA	IL255-1	V_{CEsat}		0.1	0.2	V
	I_F = ± 16 mA, I_C = 2 mA	IL255-2	V_{CEsat}			0.4	V

Note

T_{amb} = 25 °C, unless otherwise specified.
Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

CURRENT TRANSFER RATIO

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	I_F = ± 10 mA, V_{CE} = 10 V	IL255	CTR	20			%
	I_F = ± 100 mA, V_{CE} = 2 V	IL255-1	CTR	20		80	%
	I_F = ± 10 mA, V_{CE} = 10 V	IL255-2	CTR	50			%
Current transfer ratio symmetry	I_F = ± 10 mA, V_{CE} = 10 V	IL255		0.33		3.0	
		IL255-1					
	I_F = ± 10 mA, V_{CE} = 10 V	IL255-2		0.5	1	2	

TYPICAL CHARACTERISTICS

T_{amb} = 25 °C, unless otherwise specified

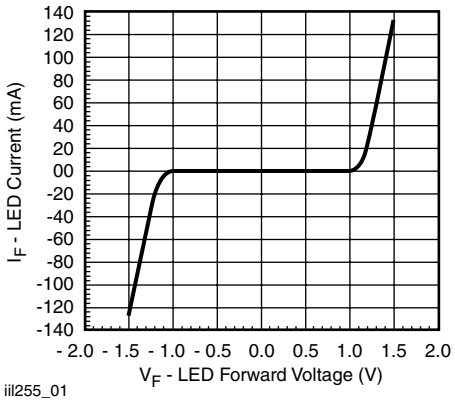


Fig. 1 - LED Forward Current vs.Forward Voltage

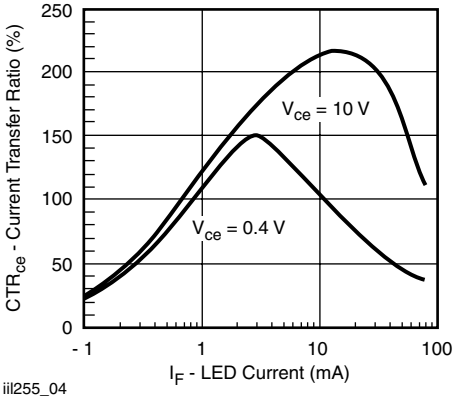


Fig. 4 - Current Transfer Ratio vs. LED Current and Collector-Emitter Voltage

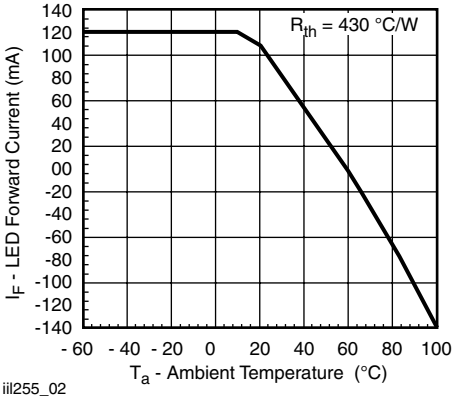


Fig. 2 - Maximum LED Current vs. Ambient Temperature

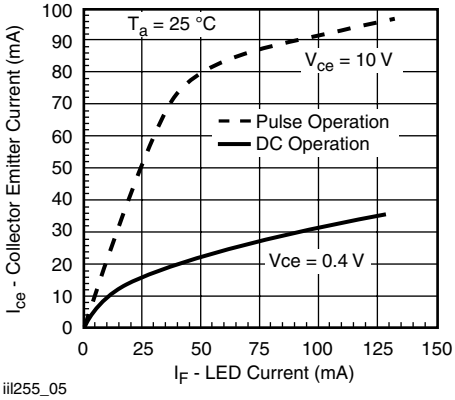


Fig. 5 - Non-Saturated and Saturated Collector Emitter Current vs. LED Current

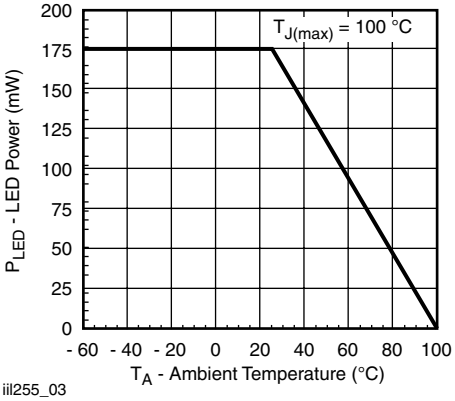


Fig. 3 - Maximum LED Power Dissipation

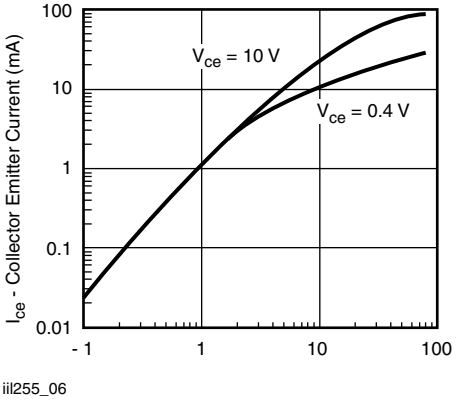


Fig. 6 - Non-Saturated and Saturated Collector Emitter Current vs. LED Current

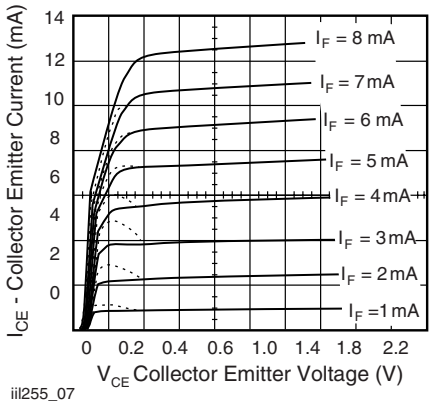
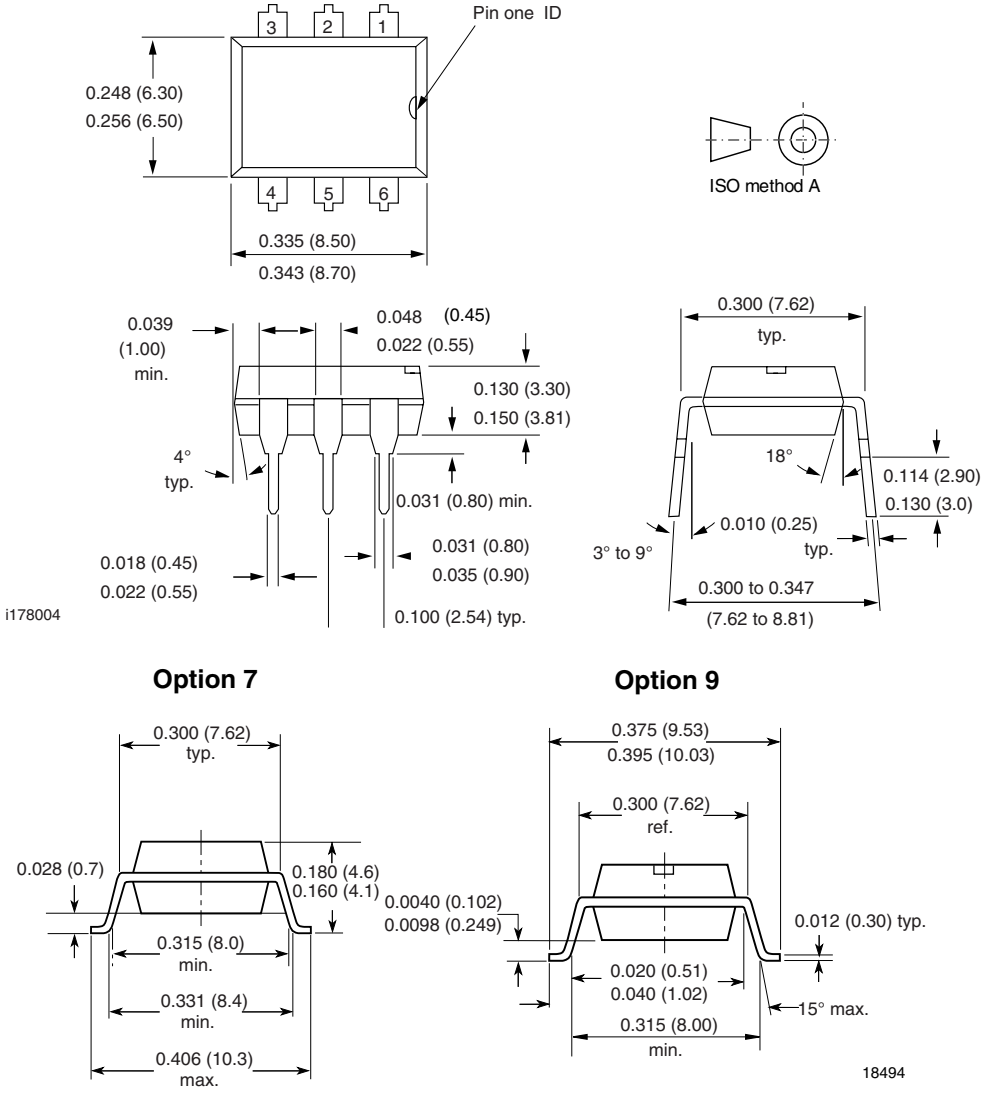


Fig. 7 - Collector Emitter Current vs. LED Collector Emitter Voltage

PACKAGE DIMENSIONS in inches (millimeters)



Option 7

Option 9

OZONE DEPLETING SUBSTANCES POLICY STATEMENT

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

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